# CALENDAR

## Upcoming: December 3–6, 3rd Workshop on Polymeric Materials for Microelectronics and Photonics Applications, MRS Endorsed.

**To list an event in the Calendar, contact J. Meiksin, Materials Research Society, 506 Keystone Drive, Warrendale, PA 15086-7573; 724-779-3004 ext. 522; fax 724-779-8313.**

**MRS, A-MRS, C-MRS, E-MRS, MRS-A, MRS-I, MRS-J, MRS-K, MRS-R, MRS-T, M-MRS, or IUMRS at the end of an entry indicates sponsorship or co-sponsorship of an event by the International Union of Materials Research Societies or one of its adhering bodies. "Endorsed" identifies events endorsed by MRS.**

**▼ identifies a new or revised entry this month.**

**See the September 2000 MRS BULLETIN for November 2000 Calendar entries.**

### DECEMBER 2000

**3–5** 18th Annual Membrane Technology/Separations Planning Conf., *Newton, MA.* Business Communications Co., 25 Van Zant St., Norwalk, CT 06855; 203-853-4266; fax 203-853-0348; e-mail buscomm1@aol.com; www.buscom.com.

**3–6 3rd Workshop on Polymeric Materials for Microelectronics and Photonics Applications,** *London, UK.* E. Suhir, Lucent Technologies, 600 Mountain Ave., Rm. 1D-443, Murray Hill, NJ 07974; 908-582-5301; fax 908-582-5106; e-mail suhir@lucent.com. **Endorsed.**

**3–8** ▼ Conf. on Computational Physics, *Gold Coast, Queensland, Australia.* P. Drummond, Dept. of Physics, Univ. of Queensland, Brisbane QLD 4072, Australia; 61-7-3365-3405; fax 61-7-3365-1242; e-mail CP2000@physics.uq.edu.au; http://CCP2000.physics.uq.edu.au/.

**4–6** ▼ Conf. on Lithography Strategies: The Business and Technical Outlook for Next Generation Lithography, *San Diego, CA.* Gorham Advanced Materials, 211 Mosher Rd., Gorham, ME 04038; 207-892-5445; fax 207-892-2210; e-mail gorham@goradv.com; www.goradv.com.

**4–8** Intl. Conf. on Processing and Manufacturing of Advanced Materials, *Las Vegas, NV.* T. Chandra, Univ. of Wollongong, Dept. of Materials Engineering, Northfields Ave., Wollongong NSW 2522, Australia; 61-42-21-3008; fax 61-42-21-3112; e-mail t.chandra@uow.edu.au.

**6–8** ACS Southeast/Southwest Regional Meeting, *New Orleans, LA.* American Chemical Society, 1115 16th St., NW, Washington, DC 20036; 202-872-4600; fax 202-872-4615; e-mail help@acs.org; www.acs.org.

**10–15** Conf. on Molecular Electronics, *Kailua-Kona, HI.* United Engineering Foundation, 3 Park Ave., 27th Floor, New York, NY 10016-5902; 212-591-7836; fax 212-591-7441; e-mail engfnd@aol.com; www.engfnd.org.

**18–20** Intl. Conf. on Fiber Optics and Photonics, *Calcutta, India.* SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; www.spie.org.

### JANUARY 2001

**6–11** AAPT and AAS Joint Winter Meeting, *San Diego, CA.* AAPT Meetings Dept., One Physics Ellipse, College Park, MD 20740; e-mail aapt–meet@aapt.org; www.aapt.org.

**7–10** Workshop on Nanostructured Materials Made from Self-Assembled Molecules and Particles, *Hindas, Sweden.* A. Palmqvist, Chalmers University of Technology, SE-412 96 Goeteborg, Sweden; fax 46-31-7722967, e-mail anders.palmqvist@surfchem.chalmers.se; www.kck.chalmers.se.

**8–9** Joint Magnetism and Magnetic Materials Conf. and the Intl. Magnetics Conf. *San Antonio, TX.* 202-973-8668; fax 202-973-8722; e-mail magnetism@courtesyassoc.com.

**8–10** PLASTEC™ West Plastics Conf., co-located with Medical Design & Manufacturing and Pacific Design & Manufacturing Conf., *Anaheim, CA.* Canon Communications, 11444 W. Olympic Blvd., Ste. 900, Los Angeles, CA 90064; 310-996-9447; 310-996-9499; www.canontradeshows.com.

**9–11** Conf. on Optics in Computing, *Lake Tahoe, NV.* Optical Society of America, 2010 Massachusetts Ave., N.W., Washington, DC 20036-1023; 202-416-1907; fax 202-416-6140; e-mail custserv@osa.org; www.osa.org/mtg_conf/.

**10–12** Ultrafast Electronics and Optoelectronics Conf., *Lake Tahoe, NV.* Optical Society of America Conf. Services, 2010 Massachusetts Ave. NW, Washington, DC 20036-1023; 202-223-0920; fax 202-416-6100; e-mail confserv@osa.org; www.osa.org.

**20–26** Photonics West Conf., *San Jose, CA.* SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; www.spie.org.

**21–26** 25th Intl. Conf. on Advanced Ceramics and Composites, *Cocoa Beach, FL.* American Ceramic Society, P.O. Box 6136, Westerville, OH 43086-6136; 614-890-4700; fax 614-899-6109; e-mail info@acers.org; www.acers.org/meetings/.

**28–31** Conf. on Advanced Solid State Lasers, *Seattle, WA.* Optical Society of America Conf. Services, 2010 Massachusetts Ave. NW, Washington, DC 20036-1023; 202-223-0920; fax 202-416-6100; e-mail confserv@osa.org; www.osa.org.

**28–31** Microtech Conf., *West London, UK.* Intl. Microelectronics and Packaging Society, 1850 Centennial Park Dr., Ste. 105, Reston, VA 20191-1517; 703-758-1060; fax 703-758-1066; e-mail imaps@imaps.org; www.imaps.org.

### FEBRUARY 2001

**5–7** IEEE Intl. Solid-State Circuits Conf., *San Francisco, CA.* D. Suiters, 202-331-2000; e-mail isscc@courtesyassoc.com.

**5–8** Conf. on Fourier Transform Spectroscopy and Optical Remote Sensing of the Atmosphere, *Coeur d'Alene, ID.* Optical Society of America Conf. Services, 2010 Massachusetts Ave. NW, Washington, DC 20036-1023; 202-223-0920; fax 202-416-6100; e-mail confserv@osa.org; www.osa.org.

**5–9** ▼ 2nd Intl. Conf. on Microelectronics and Interfaces, *Santa Clara, CA.* American Vacuum Society, 120 Wall St., 32nd Floor, New York, NY 10005; 212-248-0200; fax 212-248-0245; e-mail avsnyc@vacuum.org; http://web.vacuum.org/icmi/default.asp.

**5–9** Advanced Research Workshop on Semiconductor Nanostructures, *Blenheim, New Zealand.* D.J. Lockwood, Inst. for Microstructural Sciences, Natl. Research Council of Canada, 1191 Montreal Rd., Bldg. M-36, Ottawa, Ontario, Canada K1A 0R6; 613-993-9614; fax 613-993-6486; e-mail david.lockwood@nrc.ca.

**9–11** ▼ 19th Southern Biomedical Engineering Conf., *Birmingham, AL.* Society For Biomaterials, 13355 10th Ave. North, Ste. 108, Minneapolis, MN 55441-5510; 763-543-0908; fax 763-545-0335; www.biomaterials.org.

**9–12** ▼ Conf. on Vision Science and Its Applications, and 2nd Intl. Congress on Wavefront Sensing and Aberration-Free Refractive Correction, *Monterey, CA.* Optical Society of America, 2010 Massachusetts Ave., N.W., Washington, DC 20036-1023; 202-416-1907; fax 202-416-6140; e-mail custserv@osa.org; www.osa.org/mtg_conf/.

**11–15** TMS Annual Meeting, *New Orleans, LA.* Customer Service, TMS, 184 Thorn Hill Rd., Warrendale, PA 15086-7528; 724-776-9000; fax 724-776-3770; e-mail tmsgeneral@tms.org; http://www.tms.org/cms.

**19–22** 4th Industrial Energy Efficiency Symposium, *Washington, DC.* Office of Industrial Technologies, EE-20, U.S. Dept. of Energy, 1000 Independence Ave., S.W., Washington, DC 20585; www.oitexpo4.com.

**21–23** Intl. Conf. on Trends in Mechanical Alloying, *Jaipur, India.* P.R. Soni, Dept. of Met. Engrg., M.R. Eng. College, Jaipur 302017, India; 91-0141-702042; fax 91-0141-702954; e-mail psmt@arya.recjai.ernet.in.

**25–2** Microlithography Conf., *Santa Clara, CA.* SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; www.spie.org.

**26–28** ▼ Compound Semiconductor Outlook Conf., *San Diego, CA.* Gorham Advanced Materials, 211 Mosher Rd., Gorham, ME 04038; 207-892-5445; fax 207-892-2210; e-mail gorham@goradv.com; www.goradv.com.

### MARCH 2001

**4–8** SPIE 8th Annual Intl. Symposium on Smart Structures and Materials, *Newport Beach, CA.* SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; www.spie.org.

**5–8** Intl. Laser Safety Conf., *San Diego, CA.* Laser Inst. of America, 13501 Ingenuity Dr., Ste. 128, Orlando, FL 32826; 407-380-1553; fax 407-380-5588; e-mail lia@laserinstitute.org; www.laserinstitute.org.

**5–9** 7th Intl. Conf. on the Science of Hard Materials, *Ixtapa, Mexico.* C. Grigorescu, Dept. of Mat. Tech., INTEVEP-PDVSA, Los Teques, Venezuela, 58-2-908-6843; fax 58-2-908-6916; e-mail grigorescuc@pdvsa.com; www.upc.es/cmem/ICSHM7.

**11–14** ▼ Intl. Symposium on Advanced Packaging Materials, *Braselton, GA.* Intl. Microelectronics and Packaging Society, 1850 Centennial Park Dr., Ste. 105, Reston, VA 20191-1517; 703-758-1060; fax 703-758-1066; e-mail imaps@imaps.org; www.imaps.org.

**11–15** 10th Biennial Workshop on Organometallic Vapor Phase Epitaxy, *San Diego, CA.* TMS, 184 Thorn Hill Rd., Warrendale, PA 15086; 724-776-9000; fax 724-776-3770; e-mail tmsgeneral@tms.org; www.tms.org/cms.

**11–16** NACE 56th Annual Conf., *Washington, DC.* NACE, P.O. Box 218340, Houston, TX 77218; 281-228-6223; fax 281-228-6329; e-mail msd@mail.nace.org; www.nace.org.

**12–16** APS March Meeting, *Seattle, WA.* American Physical Society, One Physics Ellipse, College Park, MD 20740-3844; 301-209-3200; fax 301-209-0865; www.aps.org.

**17–22** Optical Fiber Communication Conf., *Anaheim, CA.* Optical Society of America Conf. Services, 2010 Massachusetts Ave. NW, Washington, DC 20036-1023; 202-416-1907; fax 202-416-6140; e-mail cust.serv@osa.org; www.osa.org.



https://doi.org/10.1557/mrs2000.230 Published online by Cambridge University Press

**19–21** Intl. Conf. on Computational Nanoscience and 4th Intl. Conf. on Modeling and Simulation of Microsystems, *Hilton Head, SC.* ICCN 2001, 4847 Hopyard Rd., Ste. 4-381, Pleasanton, CA 94588; 925-847-9152; fax 925-847-9153; e-mail wenning@dnai.com; www.cr.org.

**25–28** ▼ Conf. on Nonlinear Guided Waves and Their Applications, *Clearwater, FL.* Optical Society of America, 2010 Massachusetts Ave., N.W., Washington, DC 20036-1023; 202-416-1907; fax 202-416-6140; e-mail custserv@osa.org; www.osa.org/mtg_conf/.

**25–29** ▼ Microscopy of Semiconducting Materials XII, *Oxford, UK.* E-mail jenny@rms.org.uk; www.rms.org.uk.

**25–30** **199th Meeting of the Electrochemical Society**, *Washington, DC.* The Electrochemical Society, 65 S. Main St., Pennington, NJ 08534-2839; 609-737-1902; fax 609-737-2743; e-mail ecs@electrochem.org; http://www.electrochem.org/meetings/. **Symposium Endorsed.**

**26–27** ▼ Conf. on Ceramic Technologies for Microwave, *Denver, CO.* Intl. Microelectronics and Packaging Society, 1850 Centennial Park Dr., Ste. 105, Reston, VA 20191-1517; 703-758-1060; fax 703-758-1066; e-mail imaps@imaps.org; www.imaps.org.

## APRIL 2001

**2–4** Intl. Sherwood Fusion Theory Conf., *Santa Fe, NM.* C. Sovinec, Los Alamos Natl. Lab., T-15, MS K717, Los Alamos, NM 87545; 505-667-4394; fax 505-665-7150; e-mail sovinec@lanl.gov; http://t15web.lanl.gove/sherwood2001/.

**16–20** **MRS Spring Meeting,** *San Francisco, CA.* Materials Reserach Society, 506 Keystone Dr., Warrendale, PA 15086-7573; 724-779-3003; fax 724-779-8313; e-mail info@mrs.org www.mrs.org. **MRS**.

**18–20** ▼ Intl. Conf. on Electronics Packaging, and 15th Microelectronics Show, *Tokyo, Japan.* Secretariat, 2001 ICEP, JIEP, 3-12-2 Nishiogikita, Suginamu-ku, Tokyo 167-0042, Japan; 81-3-5310-2010; fax 81-3-5310-2011; e-mail imaps-j@jiep.or.jp; www.jiep.or.jp/index.html.

**21–26** 44th SVC Conf., *Philadelphia, PA.* Society of Vacuum Coaters, 71 Pinon Hill Place, N.E., Albuquerque, NM 87122-1914; 505-856-7188; 505-856-6716; e-mail svcinfo@svc.org.

**22–25** ACerS 103rd Annual Meeting, *Indianapolis, IN.* American Ceramic Society, P.O. Box 6136, Westerville, OH 43086-6136; 614-794-5890; fax 614-899-6109; e-mail customersrvc@acers.org; www.ceramics.org.

**22–25** Conf. on Materials and Science in Sports, *Coronado, CA.* F.H. Froes, Univ. of Idaho, Inst. of Materials and Advanced Proc., Mines Bldg., Rm. 321, Moscow, ID 83844-3026; 208-885-7989; fax 208-885-4009; e-mail imap@uidaho.edu.

**22–26** AIChE Spring National Meeting, *Houston, TX.* Meetings Dept., American Inst. of Chemical Engineers, 3 Park Ave., New York, NY 10016-5991; 212-591-7338; fax 212-591-8894; e-mail meetmail@aiche.org; www.aiche.org/conferences/.

**23–27** 13th Intl. Conf. on Wear of Materials, *Vancouver, Canada.* A. Hill, Conf. Secretariat; Elsevier Science, the Boulevard, Langford Lane, Kidlington, Oxford, Oxon OX5 1GB, UK; 44-1865-843-643; fax 44-1865-843-958; e-mail a.richardson@elsevier.co.uk; www.elsevier.com/locate/wom.

**23–27** APS April Meeting, *Washington, DC.* American Physical Society, One Physics Ellipse, College Park, MD 20740-3844; 301-209-3200; fax 301-209-0865; www.aps.org.

**24–29** ▼ 27th Annual Meeting of the Society For Biomaterials, *St. Paul, MN.* Society For Biomaterials, 13355 10th Ave. North, Ste. 108, Minneapolis, MN 55441-5510; 763-543-0908; fax 763-545-0335; www.biomaterials.org.

**28–1** ▼ APS April Meeting, *Washington, DC.* American Physical Society, One Physics Ellipse, College Park, MD 20740-3844; 301-209-3200; fax 301-209-0865; e-mail meetings@aps.org; www.aps.org.

## MAY 2001

**6–11** Conf. on Lasers and Electro-Optics, and Quantum Electronics and Laser Science Conf., *Baltimore, MD.* Optical Society of America, Conf. Services Dept., 2010 Massachusetts Ave., N.W., Washington, DC 20036-1023; 202-416-1980; fax 202-416-6100; e-mail confserv@osa.org; www.osa.org/mtg_conf.

**9–11** 14th Radio Frequency Topical Conf., *Oxnard, CA.* T.K. Mau, Univ. of California at San Diego, Fusion Energy Research Program, Rm. 460, EBU-II, 9500 Gilman Dr., La Jolla, CA 92093-0417; 858-534-2880; fax 858-534-7716; e-mail mau@aries.ucsd.edu; www-ferp.ucsd.edu/–mau/RF2001.

**12–17** ▼ 16th Intl. Conf. on Cyclotrons and Their Applications, *East Lansing, MI.* F. Marti, Natl. Superconducting Cyclotron Lab., Michigan State Univ., East Lansing, MI 48824-1321; fax 517-353-5967; e-mail marti@ncsl.msu.edu.

**14–15** ▼ Conf. on Materials Science and Engineering: Its Nucleation and Growth, *London, UK.* M. McLean, Dept. of Materials, Imperial College of Science, Technology, and Medicine, Prince Consort Rd., London SW7 2BP, UK, fax 44-20-7594-6736; e-mail m.mclean@ic.ac.uk.

**16–25** Sikkim Intl. Nanotribology Symposium, *Sikkim, India.* S.K. Biswas, Dept. Mechanical Engineering, Indian Institute of Science, Bangalore 560012, India; 91-80-3600586/3092963; fax 91-80-3600648; nanosikkim@mecheng.iisc.ernet.in; www.mecheng.iisc.ernet.in/nanosikkim.html.

**21–23** ▼ 3rd Intl. Symposium on Polymer Surface Modification, *Newark, NJ.* R.H. Lacombe, Conf. Chairman, 3 Hammer Dr., Hopewell Junction, NY 12533; 845-226-1393; fax 212-656-1016; e-mail rhl@mstconf.com; http://mstconf.com/surfmod3.htm.

**23–25** 4th Intl. Conf. on Marine Technology, *Szczecin, Poland.* K. Savage, Wessex Inst. of Technology, WIT Marketing Coordinator, Ashurst Lodge, Ashurst, Southampton SO40 7AA, UK; 44-238-029-3223; fax 44-238-029-2853; e-mail ksavage@wessex.ac.uk.

**24–25** ▼ Intl. Symposium on Surface Contamination and Cleaning, *Newark, NJ.* R.H. Lacombe, Conf. Chairman, 3 Hammer Dr., Hopewell Junction, NY 12533; 845-226-1393; fax 212-656-1016; e-mail rhl@mstconf.com; http://mstconf.com/surfclean.htm.

**28–1** ▼ 15th Intl. PLANSEE Seminar: Powder Metallurgical High Performance Materials, *Reutte, Austria.* P. Rodhammer, Conf. Secretary, PLANSEE Holding AG, A-6600 Reutte, Austria; 43-5672-600-2800; fax 43-5672-600-62800; e-mail plansee.seminar@plansee.at; www.plansee.com.

## JUNE 2001

**5–7** PLASTEC™ East Plastics Conf., co-located with Medical Design & Manufacturing East and Atlantic Design & Manufacturing Conf., *New York, NY.* Canon Communications, 11444 W. Olympic Blvd., Ste. 900, Los Angeles, CA 90064; 310-996-9447; 310-996-9499; www.canontradeshows.com.

**6–8** Conf. on Optical Engineering for Sensing and Nanotechnology, *Yokohama, Japan.* SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; www.spie.org.

**10–13** 75th Colloid and Surface Science Symposium, *Pittsburgh, PA.* S. Garoff, 412-268-6877; fax 412-681-0648; e-mail sg2e@andrew.cmu.edu; http://colloids2001.cheme.cmu.edu.

**10–14** EUROMAT 2001 Conf., *Rome, Italy.* AIM, Piazzale Rodolfo Morandi 2-1-20121 Milano, Italy; 39-2-7639-7770; fax 39-2-7602-0551; e-mail aim@fast.mi.it; www.fast.mi.it/aim/euromat.htm.

**13–15** ▼ 3rd Intl. Symposium on Acid-Base Interactions, *Newark, NJ.* R.H. Lacombe, Conf. Chairman, 3 Hammer Dr., Hopewell Junction, NY 12533; 845-226-1393; fax 212-656-1016; e-mail rhl@mstconf.com; http://mstconf.com/acidbase3.htm.

**17–20** 5th Intl. Special Emphasis Symposium on Superalloys 718, 625, 706, and Derivatives, *Pittsburgh, PA.* TMS, 184 Thorn Hill Rd., Warrendale, PA 15086; 724-776-9000; fax 724-776-3770; e-mail tmsgeneral@tms.org; www.tms.org/cms.

**18–20** ▼ 3rd Intl. Symposium on Silanes and Other Coupling Agents, *Newark, NJ.* R.H. Lacombe, Conf. Chairman, 3 Hammer Dr., Hopewell Junction, NY 12533; 845-226-1393; fax 212-656-1016; e-mail rhl@mstconf.com; http://mstconf.com/silane3.htm.

**19–21** 6th Intl. Workshop on Plasma-Based Ion Implantation, *Grenoble, France.* Y. Pauleau, CNRS-LEMD, B.P. 166, 25 Rue des Martyrs, 38042 Grenoble Cedex 9, France; 33-4-7688-1071; fax 33-4-7688-7945; e-mail pauleau@polycnrs-gre.fr; www.polycnrs-gre.fr.

**20–22** ▼ Conf. on Laser and Laser Information Technology, *Vladimir, Russia.* SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; www.spie.org.

**23–30** 12th APS Topical Conf. on Shock Compression of Condensed Matter, *Atlanta, GA.* A. Roach, Los Alamos Natl. Lab.; 505-665-6277; e-mail alita@lanl.gov.

**24–27** ▼ **2001 International Workshop on Superconductivity (ISTEC),** *Honolulu, Hawaii.* Workshop Coordinators: Tetsuji Kobayashi, ISTEC and Elton N. Kaufmann, Argonne National Laboratory; fax +81-3-3431-4044; e-mail t-kobayashi@istec.or.jp; www.istec.or.jp/ISTEC_homepage/WORK/e-workshop.html. **MRS**.

**25–28** Natl. Space and Missile Materials Symposium, *Monterey, CA.* Space and Missile Symposium, c/o Anteon Corp., 5100 Springfield St., Ste. 509, Dayton, OH 45431; 937-254-7950; fax 937-253-2296; www.usasymposium.com.

**26–1** 17th Intl. Conf. on Coherent and Nonlinear Optics, *Minsk, Belarus.* SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; www.spie.org.

**27–29** Electronic Materials Conf., *Notre Dame, IN.* TMS, 184 Thorn Hill Rd., Warrendale, PA 15086; 724-776-9000; fax 724-776-3770; e-mail tmsgeneral@tms.org; www.tms.org/cms.

## JULY 2001

**1–6** ▼ Gordon Research Conf. on Materials Processes Far from Equilibrium, *Andover, NH.* Gordon Research Conferences, Univ. of Rhode Island, P.O. Box 984, West Kingston, RI 02892-0984; e-mail app@grcmail.grc.uri.edu; www.grc.uri.edu/regpay/reg.htm.

**2–6** Conf. on Electric Charges in Nonconductive Materials, *Tours, France.* SFV Div. Dielectriques, 19 Rue du Renard, 75004 Paris, France; 33-153-019-030; fax 33-142-786-320; e-mail sfv@vide.org. www.vide.org/CSC4.html.

**15–21** ▼ 21st IUPAP Intl. Conf. on Statistical Physics, *Cancun, Mexico.* A. Robledo, IFUNAM, Apartado Postal 20-364, Mexico 01000, D.F., Mexico; 525-622-5095; fax 525-622-5008; e-mail statphys@varea.ifisicacu.unam.mx; http://varea.ifisicacu.unam.mx/statphys21.htm.

**16–20** **4th Intl. Conf. on Nitride Semiconductors** (ICNS-4), *Denver, CO.* Materials Research Society, 506 Keystone Drive, Warrendale, PA 15086; 724-779-3003; fax 724-779-8313; e-mail info@mrs.org.; www.mrs.org. **MRS**.

**16–20** ▼ 21st Int. Conf. on Defects in Semiconductors, *Giessen, Germany.* ICDS 21, D. Musaeus, I. Physikalisches Inst., Heinrich-Buff-Ring 16, D-35392 Giessen, Germany; e-mail ICDS21@physik.uni-giessen.de; www.uni-giessen.de/icds21.



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**16–20** Cryogenic Engineering Conference & International Cryogenic Materials Conference (CEC-ICMC), *Madison, WI.* Centennial Conferences, 4800 Baseline Road, A-112, Boulder, CO 80303 USA; 303-499-2299; fax 303-499-2599; e-mail cec-icmc@centennialconferences.com; www.cec-icmc.org

**18–24** 22nd Intl. Conf. on Photonic, Electronic, and Atomic Collisions, *Santa Fe, NM.* S. Datz, Oak Ridge Natl. Lab., P.O. Box 2008, Oak Ridge, TN; 865-574-4984; fax 865-574-1118; e-mail icpeac@phy.ornl.gov; http://icpeac2001.phy.ornl.gov.html.

**23–27** 13th Intl. Conf. on Vacuum UV Radiation Physics, *Trieste, Italy.* e-mail renato.gioppo@elettra.trieste.it; vuv13.elettra.trieste.it/vuv13/.

**29–3** 19th Intl. Conf. on Atomic Collisions in Solids, *Paris, France.* V.A. Esaulov, Lab. des Collisions Atomiques et Moleculaires, Bat. 351, Univ. de Paris Sud, 91405 Orsay Cedex, France; 33-69-15-76-80; fax 33-69-15-76-71; e-mail icacs19@veof1.lcam.u-psud.fr; http://veof1.lcam.u-psud.fr/idc/icacs19.html.

**29–3** SPIE Annual Meeting and Intl. Symposium on Optical Science and Technology, *San Diego, CA.* SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; www.spie.org.

**30–3** 4th Intl Conf. on Biological Physics, *Kyoto, Japan.* M. Go, Div. of Biological Science, Graduate School of Science, Nagoya Univ., Furo-cho, Chikusa-ku, Nagoya 464-8602, Japan; e-mail icbp2001@kokusai.phys.nagoya-u.ac.jp; kokusai.phys.nagoya-u.ac.jp/.

**30–3** ▼ Nonneutral Plasma Physics Workshop, *La Jolla, CA.* C.F. Driscoll, Organizing Committee Chair, Univ. of California at San Diego, Physics Dept., 0319, 9500 Gilman Dr., La Jolla, CA 92093-0319; 858-534-2489; fax 858-534-0173; e-mail fdriscol@ucsd.edu; http://sdphCA.ucsd.edu/NNP/.

## AUGUST 2001

**12–17** 10th Intl. Conf. on Phonon Scattering in Condensed Matter, *Hanover, NH.* Phonons 2001, Dept. of Physics and Astronomy, Dartmouth College, HB 6127, Hanover, NH 03755; e-mail phonons@mac.dartmouth.edu; www.dartmouth.edu/–phonon.

**13–17** ▼ 10th Canadian Semiconductor Technology Conf., *Ottawa, Ontario,* Canada. M. Lanouette, Conf. Mgr., Conf. Services Office, Natl. Research Council Canada, Bldg. M-19, Ottawa, Ontario, Canada K1A 0R6; 613-993-0414; fax 613-993-7250; e-mail marie.lanouette@nrc.ca.

**26–31** 13th European Conference on Chemical Vapor Deposition (EUROCVD13), *Athens, Greece.* www.imel.demokritos.gr/EUROCVD/Eurocvd13.html.

**27–31** Conf. on Recrystallization and Grain Growth, *Aachen, Germany.* D.A. Molodov, Inst. für Metallkunde und Metallphysik, RWTH Aachen, D-52056 Aachen, Germany; fax 49-241-888-8608; e-mail ReX&GG@imm.rth-aachen.de.

## SEPTEMBER 2001

**2–7** 200th Meeting of the Electrochemical Society and 52nd Meeting of the Intl. Society of Electrochemistry, *San Francisco, CA.* The Electrochemical Society, 65 S. Main St., Pennington, NJ 08534-2839; 609-737-1902; fax 609-737-2743; e-mail ecs@electrochem.org; www.electrochem.org.

**9–14** Conf. on Surface Modification of Materials by Ion Beams, *Marburg, Germany.* D. Rueck, Gesellschaft für Schwerionenforschung mbH, Planckstrasse 1, D-64291 Darmstadt, Germany; 49-6159-71-2603; fax 49-6159-71-2505; e-mail D. Rueck@gsf.de; www.gsi.de.

**14–16** 4th Intl. Conf. on Peer Review in Biomedical Publication, *Barcelona, Spain.* A. Flanagin, JAMA, 515 N. State St., Chicago, IL 60610; 312-464-2432; fax 312-464-5824; e-mail jama-peer@ama-assn.org.

**16–21** **Intl. Conf. on Hydrogen Effects on Material Behavior and Corrosion Deformation Interactions**, *Moran, WY.* N.R. Moody, SNL, P.O. Box 969, MS-9404, Livermore, CA 94551; 925-294-2622; fax 925-294-3410. **Endorsed.**

**17–21** Conf. on X-Ray and Neutron Capillary Optics, *Zvenigorod, Russia.* SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; www.spie.org.

**17–21** Intl. Symposium on Advanced Materials, *Islamabad, Pakistan.* A.A. Mazhar, Secretary Symposium, A.Q. Khan Res. Lab., Kahuta, P.O. Box 905, Rawalpindi, Pakistan, 92-51-928-0541; fax 92-51-928-0542; e-mail compudiv@asb.paknet.com.pk.

**18–21** Intl. Conf. on Advances in Materials and Processing Technologies, *Madrid, Spain.* AMPT'01 Congress Secretariat, Fundación Univ. Carlos III, CONGREGA, Avda. de la Universidad 30, 28911 Leganés, Spain; 34-91-624-9142; fax 34-91-624-9147; e-mail congrega@fund.uc3m.es; e-mail ampt01@ing.uc3m.es.

**23–26** TMS Fall Extraction and Process Metallurgy Meeting, *San Diego, CA.* M. Cross, School of Computing and Mathemathical Science, Univ. of Greenwich, Woolwich Campus, Wellington St., Woolwich, London SE18 6PF, UK; 44-208-331-8702; fax 44-208-331-8695.

**23–27** ▼ 3rd Intl. Symposium on Structural Intermetallics, *Jackson Hole, WY.* TMS, 184 Thorn Hill Rd., Warrendale, PA 15086; 724-776-9000; fax 724-776-3770; e-mail tmsgeneral@tms.org; www.tms.org/meetings/.

**23–27** 6th World Congress of Chemical Engineering, *Melbourne, Australia.* Meetings Dept., American Inst. of Chemical Engineers, 3 Park Ave., New York, NY 10016-5991; 212-591-7338; fax 212-591-8894; e-mail meetmail@aiche.org; www.aiche.org/conferences/.

**23–27** ACS Southeast Regional Meeting, *Savannah, GA.* American Chemical Society, 1115 16th St., NW, Washington, DC 20036; 202-872-4600; fax 202-872-4615; e-mail help@acs.org; www.acs.org.

## OCTOBER 2001

**3–5** Conf. on Photomask Technology and Management, *Monterey, CA.* SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; www.spie.org.

**10–13** ACS Midwest Regional Meeting, *Lincoln, NE.* American Chemical Society, 1115 16th St., NW, Washington, DC 20036; 202-872-4600; fax 202-872-4615; e-mail help@acs.org; www.acs.org.

**14–18** 6th Intl. Symposium on Self-Propagating High-Temperature Synthesis, *Haifa, Israel.* Dept. of Materials Engineering, TECHNION–Israel Inst. of Technology, Technion City, Haifa 32000, Israel; 972-4-829-2112; fax 972-4-832-1978; e-mail gutmanas@tx.technion.ac.il; www.technion.ac.il/technion/materials.

**17–20** ACS Southwest Regional Meeting, *San Antonio, TX.* American Chemical Society, 1115 16th St., NW, Washington, DC 20036; 202-872-4600; fax 202-872-4615; e-mail help@acs.org; www.acs.org.

**17–20** Fall Meeting of the APS Division of Nuclear Physics, *Maui, HI.* American Physical Society, One Physics Ellipse, College Park, MD 20740-3844; 301-209-3200; fax 301-209-0865; www.aps.org.

**28–31** ACS Western Regional Meeting, *Santa Barbara, CA.* American Chemical Society, 1115 16th St., NW, Washington, DC 20036; 202-872-4600; fax 202-872-4615; e-mail help@acs.org; www.acs.org.

**29–2** Meeting of the APS Div. of Plasma Physics, *Long Beach, CA.* APS Headquarters, One Physics Ellipse, College Park, MD 20740-3844; 301-209-3200; fax 301-209-0865; e-mail meetings@aps.org; www.aps.org.

## NOVEMBER 2001

**4–8** Intl. Conf. on Advanced Ceramics and Glasses, *Maui, HI.* American Ceramic Society, P.O. Box 6136, Westerville, OH 43086-6136; 614-890-4700; fax 614-899-6109; e-mail info@acers.org; www.acers.org/meetings/.

**4–8** TMS Fall Meeting, *Indianapolis, IN.* TMS, 184 Thorn Hill Rd., Warrendale, PA 15086; 724-776-9000; fax 724-776-3770; e-mail weissp@tms.org; www.tms.org.

**4–9** AIChE Annual Meeting, *Reno, NV.* Meetings Dept., American Inst. of Chemical Engineers, 3 Park Ave., New York, NY 10016-5991; 212-591-7338; fax 212-591-8894; e-mail meetmail@aiche.org; www.aiche.org/conferences/.

**5–7** ▼ 2nd Intl. Symposium on Adhesion Aspects of Thin FIlms, *Newark, NJ.* R.H. Lacombe, Conf. Chairman, 3 Hammer Dr., Hopewell Junction, NY 12533; 845-226-1393; fax 212-656-1016; e-mail rhl@mstconf.com; http://mstconf.com/adhtf2.htm.

**7–9** ▼ 3rd Intl. Symposium on Adhesion Measurement of Thin Films and Coatings, *Newark, NJ.* R.H. Lacombe, Conf. Chairman, 3 Hammer Dr., Hopewell Junction, NY 12533; 845-226-1393; fax 212-656-1016; e-mail rhl@mstconf.com; http://mstconf.com/adhmeas3.htm.

**26–30** **MRS Fall Meeting**, *Boston, MA.* Materials Research Society, 506 Keystone Drive, Warrendale, PA 15086-7573; 724-779-3003; fax 724-779-8313; e-mail info@mrs.org; www.mrs.org. **MRS**.

## DECEMBER 2001

**3–5** ▼ 2nd Intl. Symposium on Polyimides and Other High Temperature Polymers, *Newark, NJ.* R.H. Lacombe, Conf. Chairman, 3 Hammer Dr., Hopewell Junction, NY 12533; 845-226-1393; fax 212-656-1016; e-mail rhl@mstconf.com; http://mstconf.com/polyimd2.htm.

**3–7** 10th Intl. Congress of Fracture, *Honolulu, HI.* A. Hill, ICF10 Congress Secretariat, Elsevier Science, The Boulevard, Langford Lane, Kidlington, Oxford OX5 1GB, UK; 44-1865-843-643; fax 44-1865-843-958; e-mail a.richardson@elsevier.co.uk; www.elsevier.com.

**6–7** ▼ 8th Intl. Symposium on Metallized Plastics, *Newark, NJ.* R.H. Lacombe, Conf. Chairman, 3 Hammer Dr., Hopewell Junction, NY 12533; 845-226-1393; fax 212-656-1016; e-mail rhl@mstconf.com; http://mstconf.com/metalplas8.htm.

**11–15** 4th Pacific Rim Intl. Conf. on Advanced Materials and Processing, *Honolulu, HI.* S. Hanada, Tohoku Univ., Inst. for Materials Research, Katahira 2-1-1, Aoba-ku, Sendai 980-8577, Japan; 81-22-215-2115; fax 81-22-215-2116; e-mail ccpricm4@imr.tohoku.ac.jp.

## JANUARY 2002

**6–11** ▼ 13th Intl. Conf. on Ternary and Multinary Compounds, *Dead Sea, Israel.* D. Cahen, Dept. of Materials and Interfaces, Weizmann Inst. of Science, Rehovoth, Israel 76100; 972-0-89-34-2246; fax 972-0-89-34-4139; e-mail david [illegible]ahen@w[illegible]zmann.ac.il; www.weizm[illegible]n.ac.il/[illegible]aterial/.

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